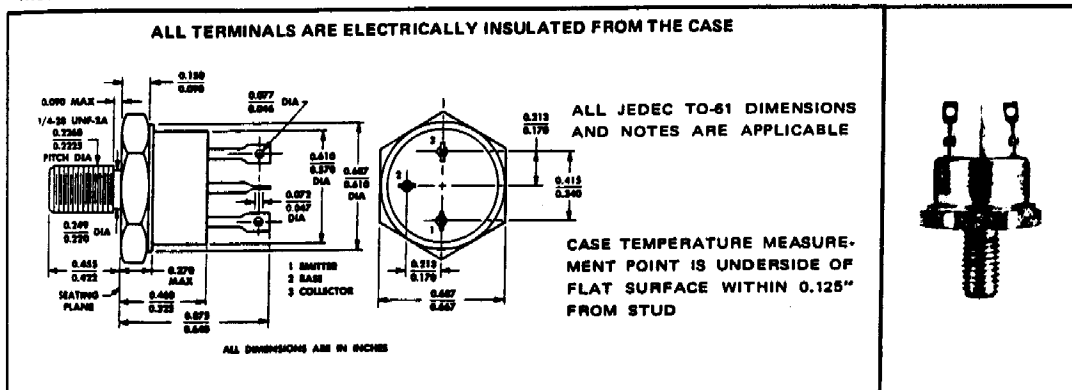


TYPE 2N6128
N-P-N SILICON POWER TRANSISTOR

**HIGH-FREQUENCY, HIGH-POWER TRANSISTOR WITH
 COMPUTER-DESIGNED ISOTHERMAL GEOMETRY**

- 40 mJ Reverse Energy Rating with $I_C = 20$ A and 4 V Reverse Bias
- Isolated Stud Package
- 100 W at 50°C Case Temperature
- Min f_T of 50 MHz at 5 V, 2 A
- Designed for Complementary Use with 2N6127

*mechanical data

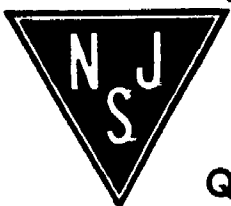


*absolute maximum ratings at 25°C case temperature (unless otherwise noted)

Collector-Base Voltage	100 V
Collector-Emitter Voltage (See Note 1)	80 V
Emitter-Base Voltage	6 V
Continuous Collector Current	10 A
Peak Collector Current (See Note 2)	20 A
Continuous Base Current	3 A
Safe Operating Areas	See Figures 6 and 7
Continuous Device Dissipation at (or below) 50°C Case Temperature (See Note 3)	100 W
Continuous Device Dissipation at 100°C Case Temperature (See Note 3)	67 W
Unclamped Inductive Load Energy ($V_{BE(off)} = 0$, See Note 4)	50 mJ
Unclamped Inductive Load Energy ($V_{BE(off)} = -4$ V, See Note 4)	40 mJ
Operating Collector Junction Temperature Range	-65°C to 200°C
Storage Temperature Range	-65°C to 200°C
Terminal Temperature 1/8 Inch from Case for 60 Seconds	300°C

- NOTES:
1. This value applies when the base-emitter-diode is open-circuited.
 2. This value applies for $t_w < 0.3$ ms, duty cycle $< 10\%$.
 3. Derate linearly to 200°C case temperature at the rate of 0.67 W/°C.
 4. These ratings are based on the capability of the transistor to operate safely in the circuit of Figure 2.

JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.



TYPE 2N6128
N-P-N SILICON POWER TRANSISTOR

*electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
V _{(BR)CEO} Collector-Emitter Breakdown Voltage	I _C = 200 mA, I _B = 0, See Note 5	80		V
I _{CEO} Collector Cutoff Current	V _{CE} = 40 V, I _B = 0		100	μA
I _{CES} Collector Cutoff Current	V _{CE} = 60 V, V _{BE} = 0		10	μA
	V _{CE} = 100 V, V _{BE} = 0		1	mA
	V _{CE} = 60 V, V _{BE} = 0, T _C = 150°C		500	μA
I _{EBO} Emitter Cutoff Current	V _{EB} = 5 V, I _C = 0		10	μA
	V _{EB} = 6 V, I _C = 0		1	mA
h _{FE} Static Forward Current Transfer Ratio	V _{CE} = 5 V, I _C = 100 mA		20	
	V _{CE} = 5 V, I _C = 5 A		30	120
	V _{CE} = 5 V, I _C = 10 A	See Notes 5 and 6	15	
	V _{CE} = 5 V, I _C = 5 A, T _C = -55°C		12	
V _{BE} Base-Emitter Voltage	I _B = 0.5 A, I _C = 5 A		1.8	
	V _{CE} = 5 V, I _C = 5 A	See Notes 5 and 6	1.8	V
	V _{CE} = 5 V, I _C = 10 A		2.2	
V _{CE(sat)} Collector-Emitter Saturation Voltage	I _B = 0.5 A, I _C = 5 A		0.9	
	I _B = 1 A, I _C = 10 A	See Notes 5 and 6	2.2	V
h _{fe} Small-Signal Common-Emitter Forward Current Transfer Ratio	V _{CE} = 5 V, I _C = 0.2 A, f = 1 kHz	20		
h _{fe} Small-Signal Common-Emitter Forward Current Transfer Ratio	V _{CE} = 5 V, I _C = 2 A, f = 20 MHz	2.5		
C _{obo} Common-Base Open-Circuit Output Capacitance	V _{CB} = 10 V, I _E = 0, f = 1 MHz		275	pF

- NOTES: 5. These parameters must be measured using pulse techniques. t_w = 300 μs, duty cycle < 2%.
6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 0.125 inch from the device body.

thermal characteristics

PARAMETER	MAX	UNIT
R _{θJC} Junction to Case Thermal Resistance	1.5	°C/W

switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS†	TYP	UNIT
t _{on} Turn-On Time	I _C = 10 A, I _{B(1)} = 1 A, I _{B(2)} = -1 A,	0.5	μs
t _{off} Turn-Off Time	V _{BE(off)} = -3.8 V, R _L = 3 Ω, See Figure 1	1.3	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

*JEDEC registered data

